CD		CAT	NC
25		LAI	C

CUSTOMER .

SAMPLE CODE : SH128800T004-ZFC

MASS PRODUCTION CODE . PH128800T004-ZFC

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 008

DRAWING NO. (Ver.) . LMD-PH128800T004-ZFC (Ver.005)

PACKAGING NO. (Ver.) PKG-PH128800T004-ZFC (Ver.004)

Customer Approved

Date:

Approved	Checked	Designer
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Preliminary specification for design input

Specification for sample approval

2020.05.12 TWRD APR

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
03/13/2017	01	001	New Drawing	(-	Stephen
03/21/2017	01	002	Update Spec	15 · 16	Stephen
05/15/2017	01	003	New Sample	-	Stephen
07/19/2017	01	004	Update Packages Version	-	Stephen
10/18/2017	01	005	Update LCD Module Drawing Version	-	Stephen
05/09/2018	01	006	Modify Spec	- /	Stephen
12/20/2018	01	007	Modify Spec 1.1 Features - Display Mode 1.3 Maximum Ratings - Operating Temperature 1.4 DC Electrical Characteristics 1.7 Touch Panel - Operating Temperature 2.2 Interface Pin Description – Remove J7 \ J8 2.3 Change Timing Characteristics to HDMI	4 · 5 · 9 · 11 · 12	Stephen
05/11/2020	01	800	Update Package	-	Stephen



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Appendix : LCM Drawing.

LCM Packaging Specifications



1. SPECIFICATIONS

1.1 Features

Item	Standard Value				
Touch Panel	Projective Capacitive Touch Panel				
TOUCH Faller	USB HID Touch				
Screen Size(inch)	10.1(Diagonal)				
Resolution	1280* (R · G · B) * 800 Dots				
Display Mode	Full Viewing Angle 、 Transmissive 、 Normally Black				
Color	16.7M				
Weight	458.7 g				
Interface	HDMI				
	THIS PRODUCT CONFORMS THE ROHS OF PTC				
ROHS	Detail information please refer website :				
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1				

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	254.96(W) * 173.6 (L) * 26.2 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	216.96 (W) * 135.60 (L)	mm

Note: For detailed information please refer to LCM drawing.



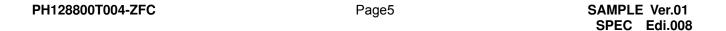
1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	VCC	-	-0.3	+23.0	V
i oner cuppiy venage	VBus	-	-0.3	+6.0	V
Logic Voltage	BL_PWM	-	-0.3	+5.5	V
Operating Temperature	T _{OP}	-	-20	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tst	- (-30	+80	$^{\circ}\!\mathbb{C}$
Storage Humidity	H _D	Ta<60 ℃	-	90	%RH

1.4 DC Electrical Characteristics

Item	Symbol	Status	Condition	Min.	Тур.	Max.	Unit
Power Supply	VCC	I	VCC-GND	11.5	12.0	12.5	V
Voltage	VBus	-	V _{Bus} -GND	4.75	5.0	5.25	V
Power Supply	ICC	_	VCC=12.0v	-	500	550	mA
Current	Bus	I	V _{Bus} =5.0v	-	50	100	mA
Logic Voltage	BL_PWM	-	BL_EN=5.0v	0	-	5.0	V
PWM Frequency	FPWM	-		100	-	20000	HZ

Note: Maximum current from RGB full-display





1.5 Optical Characteristics

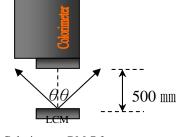
TFT LCD Panel Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	-
Response Tir	ne	Tr + Tf	-	-	25	50	ms	Note2
	Тор	ΘΥ+		75	85	-		
Viewing Angle	Bottom	ΘΥ-	CR ≥ 10	75	85	-	Deg.	Note4
Viewing Angle	Left	ΘХ-	CR 2 10	75	85	1	Deg.	Note4
	Right	ΘХ+		75	85	-		
Contrast Rat	io	CR		600	800	ı	1	Note3
	White	X		0.265	0.315	0.365		
	vviile	Υ		0.303	0.353	0.403		
0 1 (0)5	Red	Х		0.541	0.591	0.641		
Color of CIE	Reu	Υ	-	0.299	0.349	0.399		Natad
Coordinate (With B/L)	Green	X		0.294	0.344	0.394	_	Note1
(VVIII 12/2)	Orccii	Υ		0.531	0.581	0.631		
	Blue	Х		0.104	0.154	0.204		
	Diue	Υ		0.096	0.146	0.196		
Average Brightr Pattern=White D		IV	IF=80 mA	350	450	-	cd/m2	Note1
Luminance Unifo	ormity	YU	IF=80 mA	70	75	-	%	Note1

Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H → no wind → dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast



Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

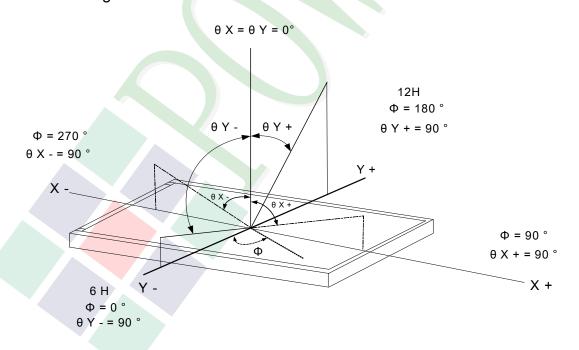
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

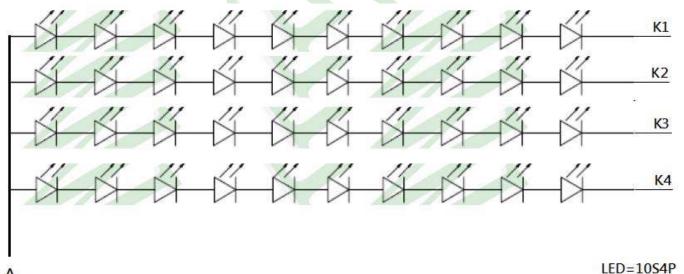
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Power Dissipation	Pd	-	-	100	-	mW
LED Forward Current	IF	1 LED	-	-	30	mA
LED Reverse Voltage	VR	1 LED	-	-	1.2	٧

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Voltage for LED Backlight	VF	If-90m 1	27.5	31.0	34.0	V	
Current for LED Backlight	IF	IF If=80mA		80	>	mA	
Color	White						

Other Description

Item	Conditions	Description
Life Time	Ta =25°C If= 80 mA	50000 hrs



LLU-1034F



1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	10.1"
Touch Type	Projective Capacitive Touch Panel
Input Method	Finger / 5 Points touch
Output Interface	USB
IC	mxT1066T + SAM D21E

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	217.96 (W) * 136.60 (L)	mm

Absolute Maximum Ratings

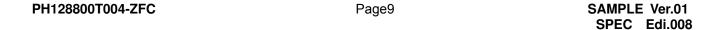
	9 -				
Item	Symbol	Condition	Min.	Max.	Unit
Supply Voltage	VDD_5.0	-	-0.3	+6.0	V
Operating Temperature	Тор	//	-20	+70	°C
Storage Temperature	Тѕт	- "	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD_5.0		-	5.0	-	V

Touch Panel IC Read/Write description & Register Mapping

Reference: Atmel Touch Driver Porting Reference Guide.





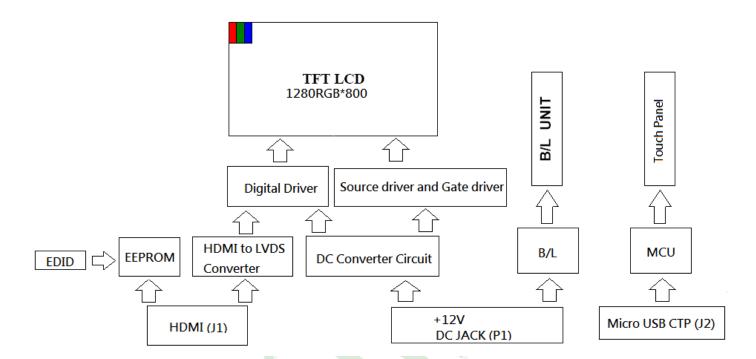
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

2.2.1 (J1: HDMI 1.3 A type Interface)

Pin#	Name	Description
1	TX2+	TMDS Data 2+
2	TX2 Shield	TMDS Data 2 Shield
3	TX2-	TMDS Data 2-
4	TX1+	TMDS Data 1+
5	TX1 Shield	TMDS Data 1 Shield
6	TX1–	TMDS Data 1-
7	TX0+	TMDS Data 0+
8	TX0 Shield	TMDS Data 0 Shield
9	TX0-	TMDS Data 0-
10	TXC+	TMDS Clock+
11	TXC Shield	TMDS Clock Shield
12	TXC-	TMDS Clock-
13	CEC	CEC
14	NC	No connection
15	SCL	Serial Clock for DDC
16	SDA	Serial Data for DDC
17	GND	Power Ground
18	V5V	+5V Power for HDMI
19	Hot Plug Detect	Hot Plug Detect



2.2.2 (J2: Micro USB Capacitive Touch Panel Interface)

Pin#	Name	Description
1	VBus	VBus 4.75V-5.25V
2	D-	Data-
3	D+	Data+
4	ID	No connection
5	GND	Power Ground.

2.2.3 (PJ1: POWER DC JACK Interface)



Hold Φ6.4mm / Center Pin Φ 2.0mm

Pin#	Name	Description
1	VCC	+12V Power
2	GND	Power Ground



2.3 HDMI Characteristics

2.3.1 Signal DC&AC Characteristics

DC ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP MAX	UNIT			
V_{ID}	Analog input differential voltage (1)		75	1200	mV			
V _{IC}	Analog input common-mode voltage ⁽¹⁾		$AV_{DD} - 300$	$AV_{DD} - 37$	mV			
V _{I(OC)}	Open-circuit analog input voltage		AV _{DD} – 10	AV _{DD} + 10	mV			
I _{DD(2PIX)}	Normal 2-pix/clock power supply current (2)	ODCK = 82.5 MHz, 2-pix/clock		370	mA			
I _{PD}	Power-down current (3)	PD = low		10	mA			
I _{PDO}	Output drive power-down current ⁽³⁾	PDO = low		35	mA			

(1) Specified as dc characteristic with no overshoot or undershoot

(2) Alternating 2-pixel black/2-pixel white pattern. ST = high, STAG = high, QE[23:0] and QO[23:0] C_L = 10 pF.

Analog inputs are open circuit (transmitter is disconnected from TFP401/401A).

AC ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{ID(2)}	Differential input sensitivity ⁽¹⁾		150		1560	mV _{p-p}
t _{ps}	Analog input intra-pair (+ to –) differential skew (2)				0.4	t _{bit} (3)
t _{ccs}	Analog input inter-pair or channel-to-channel skew ⁽²⁾				1	t _{pix} ⁽⁴⁾
t _{ijit}	Worst-case differential input clock jitter tolerance $^{(2)(5)}$		50			ps
	Fall time of data and control signals (6)(7)	ST = low, C _L = 5 pF			2.4	ns
t _{f1}	Fall time of data and control signals (5)(7)	ST = high, C _L = 10 pF			1.9	115
	Rise time of data and control signals ⁽⁶⁾⁽⁷⁾	ST = low, C _L = 5 pF			2.4	ne
ţ ₁	Rise time of data and control signals (A)	ST = high, C _L = 10 pF			1.9	ns
t _{r2}	Rise time of ODCK clock ⁽⁶⁾	ST = low, C _L = 5 pF			2.4	
	Rise time of ODCK dock**	ST = high, C _L = 10 pF			1.9	ns
	Fall time of ODOK alask (6)	ST = low, C _L = 5 pF			2.4	
t _{f2}	Fall time of ODCK clock ⁽⁶⁾	ST = high, C _L = 10 pF			1.9	ns
		1 pixel/clock, PIXS = low, OCK_INV = low	1.8			
t _{su1}	Setup time, data and control signal to falling edge of ODCK	2 pixel/clock, PIXS = high, STAG = high, OCK_INV = low	3.8			ns
		2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = low	0.7			
		1 pixel/clock, PIXS = low, OCK_INV = low	0.6			
t _{h1}	Hold time, data and control signal to falling edge of ODCK	2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = low	2.5			ns
		2 pixel/clock, PIXS = high, STAG = high, OCK_INV = low	2.9			

Specified as ac parameter to include sensitivity to overshoot, undershoot and reflection.

(2) By characterization

(3) t_{bit} is 1/10 the pixel time, t_{pix}

(5) Measured differentially at 50% crossing using ODCK output clock as trigger

(6) Rise and fall times measured as time between 20% and 80% of signal amplitude.

⁽⁴⁾ t_{pix} is the pixel time defined as the period of the RxC input clock. The period of ODCK is equal to t_{pix} in 1-pixel/clock mode or 2t_{pix} when in 2-pixel/clock mode.

⁽⁷⁾ Data and control signals are QE[23:0], QO[23:0], DE, HSYNC, VSYNC. and CTL[3:1].



AC ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
		1 pixel/clock, PIXS = low, OCK_INV = high	2.1				
t _{su2}	Setup time, data and control signal to rising edge of ODCK	2 pixel/clock, PIXS = high, STAG = high, OCK_INV = high	4			ns	
		2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = high	1.5				
		1 pixel/clock, PIXS = low, OCK_INV = high	0.5				
t _{h2}	Hold time, data and control signal to rising edge of ODCK	2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = high	2.4			ns	
		2 pixel/clock, PIXS = high, STAG = high, OCK_INV = high	2.1				
	ODCK fraguency	PIX = low (1-PIX/CLK)	25		165	MHz	
fodck	ODCK frequency	PIX = high (2-PIX/CLK)	12.5		82.5	MHZ	
	ODCK duty-cycle		40%	50%	60%		
t _{pd(PDL)}	Propagation delay time from PD low to Hi-Z outputs				9	ns	
t _{pd(PDOL)}	Propagation delay time from PDO low to Hi-Z outputs				9	ns	
t _{t(HSC)}	Transition time between DE transition to SCDT low ⁽⁸⁾			1e6		t _{pix}	
t _{t(FSC)}	Transition time between DE transition to SCDT high ⁽⁸⁾			1600		t _{pix}	
t _{d(st)}	Delay time, ODCK latching edge to QE[23:0] data output	STAG = low, PIXS = high		0.25		t _{pix}	

(8) Link active or inactive is determined by amount of time detected between DE transitions. SCDT indicates link activity.





2.3.2 Parameter Measurement Information

PARAMETER MEASUREMENT INFORMATION

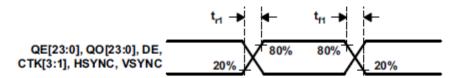


Figure 1. Rise and Fall Times of Data and Control Signals

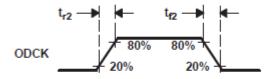


Figure 2. Rise and Fall Times of ODCK

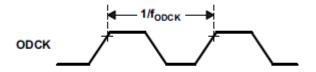


Figure 3. ODCK Frequency

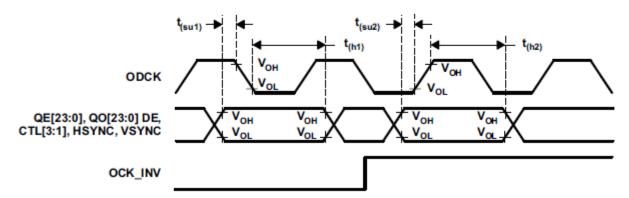


Figure 4. Data Setup and Hold Times to Rising and Falling Edges of ODCK



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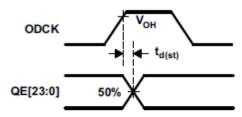


Figure 5. ODCK High to QE[23:0] Staggered Data Output

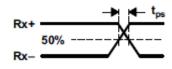


Figure 6. Analog Input Intra-Pair Differential Skew

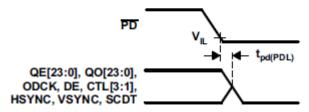


Figure 7. Delay From PD Low to Hi-Z Outputs

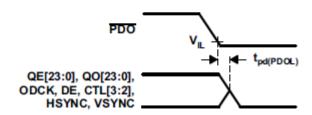


Figure 8. Delay From PDO Low to Hi-Z Outputs

PARAMETER MEASUREMENT INFORMATION (continued)

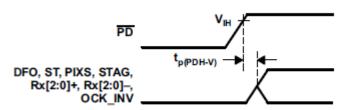


Figure 9. Delay From PD Low to High Before Inputs Are Active

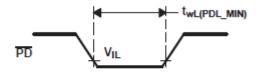


Figure 10. Minimum Time PD Low





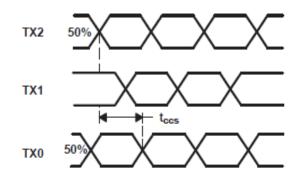


Figure 11. Analog Input Channel-to-Channel Skew

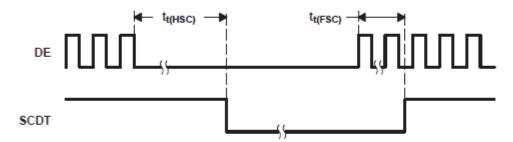


Figure 12. Time Between DE Transitions to SCDT Low and SCDT High

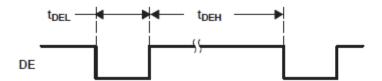
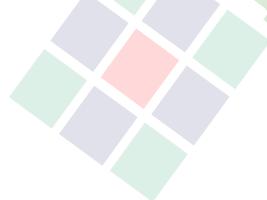


Figure 13. Minimum DE Low and Maximum DE High

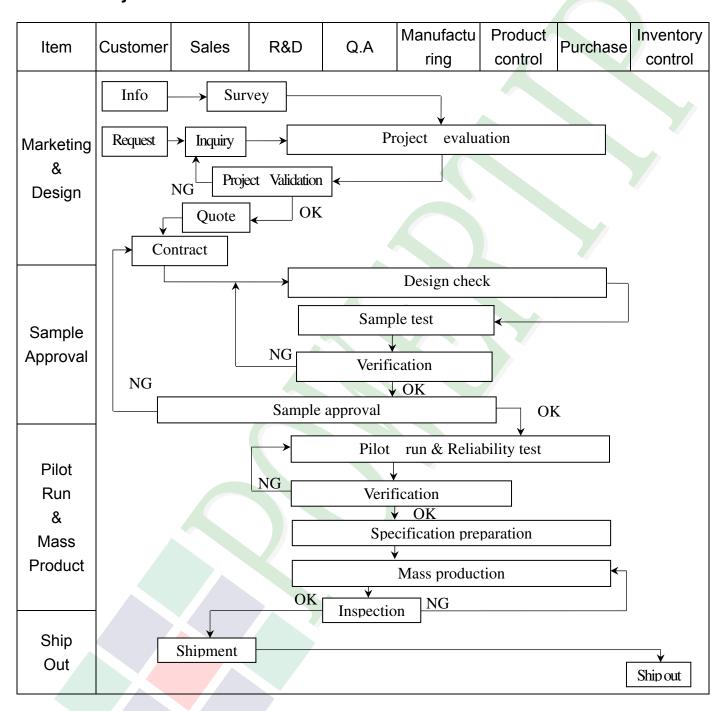
DETAILED DESCRIPTION



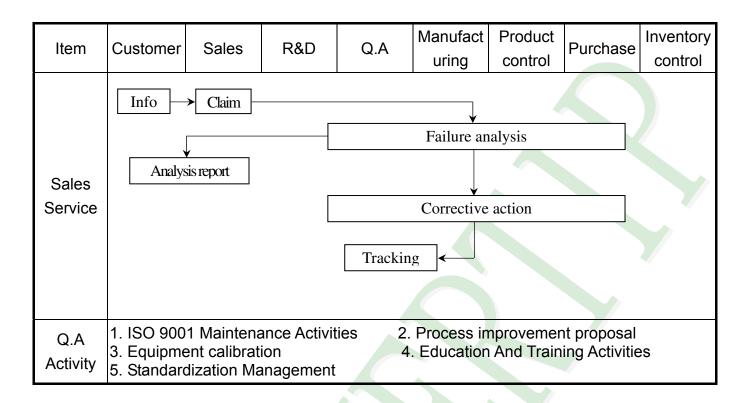


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

♦Scope: The document shall be applied to TFT-LCD Module for 3. 5" −15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge, MIL-STD, Powertip Tester, Sample

◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5

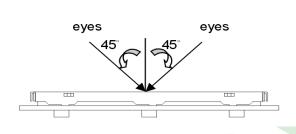
♦OUT Going Defect Level: Sampling.

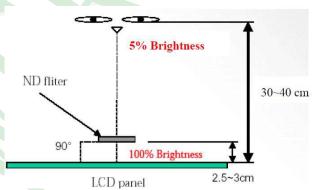
♦Standard of the product appearance test:

a. Manner of appearance test:

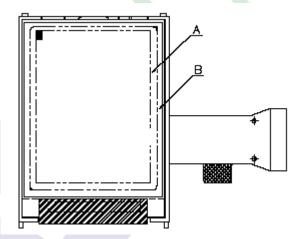
(1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux) , and distance of view must be at 30~40 cm.

(2). The test direction is base on about around 45° of vertical line.





(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)

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◆Specification For TFT-LCD Module 3.5...~15...:

NO₽	Item₽		Criterion.					
		1. 1The part number is inconsistent with work order of production.						
01₽	Product condition.	1.2 Mixed	produ	ıct types.₽		Major₽		
		1. 3 Assemb	bled ii	n inverse direction.«	ر	Major₽		
02€	Quantity₽	2. 1The qua	2. 1The quantity is inconsistent with work order of production.					
03₽	Outline dimension	3. 1Product		ension and structu	re must conform to structure	Major₽		
04₽		4. 1 Missin	g line	character and icon	ته	Major₽		
		4. 2 No fun	ction	or no display.₽		Major₽		
	Electrical Testing↓	4. 3 Display malfunction.						
		4. 4 LCD viewing angle defect.₽						
		4. 5 Current consumption exceeds product specifications.						
		4. 6Mura cannot be seen through 5% ND filter at 50% Gray 4, , should be judged by the viewing angle of 90 degree.4						
		_		Item₽	Acceptance (Q'ty)&			
				Bright Dot₽	<u>≨</u> 4₽ ₽			
	Dot defect	D D	Oot	Dark Dot₽	<u>≨</u> 5₽ ₽			
	ψ 	De	efect⊹	Joint Dot 🕫	<u>≨</u> 3₽ ₽			
05₽	(Bright dot,↓ Dark dot) ↓			Total₽	<u>≨</u> 7₽	Minor₽		
	on -display	5.1 Inspection pattern: full white, full black, Red, Green and						
	Oii -dispiay÷	blue screens. ↔						
		5. 2 It is defined as dot defect if defect area >1/2 dot.						
		5. 3 The distance between two dot defect ≥5 mm.↓						
		5. 4 Bright dot that can not be seen through 5% ND filter.						



◆Specification For TFT-LCD Module 3. 5″~15″:

NO₽	Item.	Criterion₽									
	t t t	6. 1 Ro	und type (Non-displa	y or dis	splay):⊬					
	4	*	Dimensio	n (diamete	r = Ф)«	Acceptar A area₽	nce (Q'ty)	د د			
	4			Φ ≤ 0.	25₽	Ignore.	Darca	÷			
	Black or white		0.25	< Φ ≦ 0.	50↩	5€	┪_	٠			
	Dot, scratch,↓ contamination↓			Φ > 0		0∻	Ignore	ė.			
	Parried toward		•	Total₽		5₽		٠			
	Round type X.	6. 2 Lin↓	ie type(No	n-display o	r displa	ay):⊬					
	<u>Y.</u> ,	mod	dule size₊	Length	W	idth (W)₽	Acceptanc		-		
06₽	·			(L)₽		W ≤ 0.03¢	A area∉ Ignore∉	B area	47	Minor	
	$\Phi = (x+y)/2\psi$				0.03	<w 0.05€<="" td="" ≤=""><td>4¢</td><td></td><td>٥</td><td></td></w>	4¢		٥		
			3.5" to less 9"∻	L ≦5.0₽		<w <u="">≤ 0.10₽</w>		† .	, G		
	Line type	3.5"		4		W >0.10₽	As round type₽	Ignore∉	٦		
	/ ¥ W∻			Total₽			54□		Ç		
	\		9" to 15"			W ≤ 0.05¢	Ignore₽		٦		
	Γ ⁴ , 1				L ≤10.0₽	0.05	<w <u="">≦ 0.10₽</w>	5₽		Ç	
		9"				W >0.10€	As round type₽	Ignore	ته		
				Total₽		5₽		Ð			
		4									
)imension	(diameter:	4 Va	Accepta	nce (Q'ty)√	₽			
		<u> </u> *)imension	(шашетег:	Ψ)~	A area₽	B are	a⇔ ↔			
				$\Phi \leq 0.25$	٦	Ignore₽		47			
07↩	Polarizer↓ Bubble↓		0.25 <	$\Phi \leq 0.50$	ę	4₽		٦		Minor	
	Dunnie		0.50 <	Φ ≦ 0.80	ę	14	Ignoi	re+ P			
				Φ >0.80	Ę,	04□		47			
			1	[otal∉		5₽		47			



◆Specification For TFT-LCD Module 3. 5″ ~15″ :

41	
Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1 General glass chip: 8. 1.1 Chip on panel surface and crack between panels: SP Ye [NG] X Y X Y Seal width X Y Seal width Crack can't enter viewing area Crack can't exceed the half of SP width.	Minor



◆Specification For TFT-LCD Module 3. 5″_~15″ :

NO₽	Item↵	Criterion₄ ³				
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:				
		X_{1} Y_{2} Z_{3} A_{2} A_{3} A_{4} A_{5} A_{5				
08₽	The crack of glass↔	Crack can't exceed the half of SP width. 1/2 t < Z ≦2 te	Minor⊹			
		8. 2 Protrusion over terminal: 8. 2. 1 Chip on electrode pad: □				
		X X Y				
		W W				
		Front e $\leq ae$ $\leq 1/2 \text{ We}$ $\leq te$				
		Back φ $\leq a\varphi$ $\leq W\varphi$ $\leq 1/2 t\varphi$				



◆Specification For TFT-LCD Module 3. 5<u></u>~15<u>"</u> ~15<u>"</u> =

NO₽	Item₽	Criterion <i>₽</i>					
3/1/2/2/2	Item↔ The crack of glass↔	102 W 7-05	Level				
		8.2.4 Cracking: + Not Allowed+					



◆Specification For TFT-LCD Module 3. 5″ ~15″ =

· NO	Item₽	Criterion.	Level₽
09₽	Backlight elements₊³	9. 1 Backlight can't work normally.↓	Major∂
		9. 2 Backlight doesn't light or color is wrong.	Major∂
		9. 3 Illumination source flickers when lit.	Major₽
10↔	General appearance₽	10. 1Pin type > quantity > dimension must match type in structure diagram.€	Major∂
		10. 2 No short circuits in components on PCB or FPC.	Major⊍
		10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major₽
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor↓
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor∂
		10.6 The PCB or FPC between B/L assembled distance(PCB or ↓ FPC) is ≤1.5 mm.↓	Minor∂



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

						(VCI.DOI)
TEST ITEM	TEST CONDITION					
High Temperature Storage Test	Keep in +80 ±5°C 240 hrs					
Low Temperature Storage Test	Keep in -30 ±5°C 240 hrs					
High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 240 hrs (Excluding the polarizer)					
Temperature Cycling Storage Test		−30° ℃	→ +25°C -		+25°C	
		(30mins)	(5mins)	(30mins)	(5mins)	
		`	20 C	ycle		
	Air Dischar	ge:		Contact Disc	charge:	
	Apply 2 KV	with 5 time	es	Apply 250 V	with 5 tin	ies
					r each pola	rity +/-
ESD Test	_			35℃		
	2.Humidity relative: 30%~60%					
	3.Energy Storage Capacitance(Cs+Cd): 150pF±10%					
Vibration Test				_)	
(Packaged)						
	3.Each dire	ction (X > Y	' \ Z) durati	on for 2 Hrs		
		Packing V	Weight (Kg)	Drop Hei	ight (cm)	
Drop Test (Packaged)		0	~ 45.4	12	22	
		45. 4	~ 90.8	7	6	
		90.8	~ 454	6	1	
		0ve	r 454	4	6	
	Drop Direct	ion : ※1 co	rner / 3 edge	es / 6 sides eac	ch 1time	•
	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Temperature Cycling Storage Test ESD Test Vibration Test (Packaged)	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Temperature Cycling Storage Test Air Dischar Apply 2 KV Discharge fe 1.Temperat 2.Humidity 3.Energy St 4.Discharge 5.Discharge Single Disch (Tolerance in 1.Sine wave 2.The ampli 3.Each direct Drop Test (Packaged) Drop Test (Packaged)	High Temperature Storage Test Low Temperature Storage Test High Temperature/ High Humidity Storage Test Keep in -30 ±5°C 240 Keep in -30 ±5°C 240 Keep in +60 °C /90% (Excluding the polarized in the polari	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Keep in +80 ±5°C 240 hrs Keep in -30 ±5°C 240 hrs Keep in +60 °C / 90% R.H duration (Excluding the polarizer) Temperature Cycling Storage Test Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1.Temperature ambiance : 15°C ~ € 2.Humidity relative : 30% ~ 60% 3.Energy Storage Capacitance (Cs+ 4.Discharge Resistance (Rd) : 330 Ω 5.Discharge, mode of operation : Single Discharge (time between su (Tolerance if the output voltage ind 1.Sine wave 10~55 Hz frequency (2.The amplitude of vibration :1.5 r 3.Each direction (X ` Y ` Z) duration Packing Weight (Kg) 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Keep in $+80^{\circ}\pm5^{\circ}$ C 240 hrs Storage Test Air Discharge: Contact Disc Apply 250 V discharge for each polarity +/- 1.Temperature ambiance : 15° C $\rightarrow 480^{\circ}$ C	High Temperature Storage Test Low Temperature Storage Test High Temperature / High Humidity Storage Test Keep in $-30 \pm 5^{\circ}\mathbb{C}$ 240 hrs Keep in $+80 ^{\circ}\mathbb{C}$ / 90% R.H duration for 240 hrs (Excluding the polarizer) Temperature Cycling Storage Test Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1.Temperature ambiance: $15^{\circ}\mathbb{C} \sim 35^{\circ}\mathbb{C}$ 2.Humidity relative: $30\% \sim 60\%$ 3.Energy Storage Capacitance(Cs+Cd): $150pF\pm10\%$ 4.Discharge, mode of operation: Single Discharge (time between successive discharges at (Tolerance if the output voltage indication: $\pm 5\%$) Vibration Test (Packaged) Vibration Test (Packaged) Drop Test (Packaged) Drop Test (Packaged) Keep in $+80 \pm 5^{\circ}\mathbb{C}$ 240 hrs Cylon R.H duration for 240 hrs (30mins) (5mins) (30mins) (5mins) (30mins) (5mins) (30mins) (5mins) (30mins) (5mins) (30mins) (5mins) (20 Cycle Contact Discharge: Apply 250 V with 5 time discharges at 250 C 2.Humidity relative: $30\% \sim 60\%$ 3.Energy Storage Capacitance(Cs+Cd): $150pF\pm10\%$ 4.Discharge, mode of operation: Single Discharge (time between successive discharges at (Tolerance if the output voltage indication: $\pm 5\%$) 1.Sine wave $10\sim55$ Hz frequency (1 min/sweep) 2.The amplitude of vibration: 1.5 mm 3.Each direction (X \ Y \ Z) duration for 2 Hrs Packing Weight (Kg) Drop Height (cm) 0 \(-45.4 \) 122 45.4 \(-90.8 \) 76 90.8 \(-454 \) 61

©Result Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state)

Temperature: +20~30°C Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

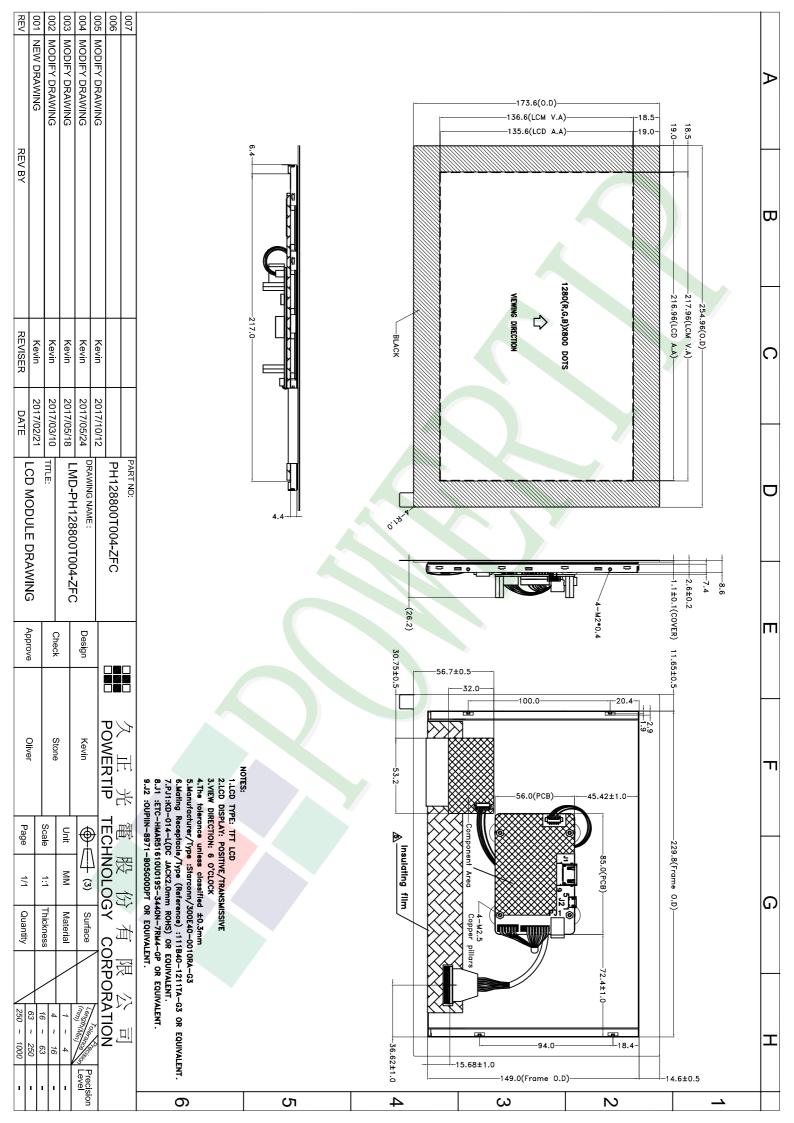
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 - Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver	004				Approve	Check	Contact		
Ver.004 LCM包装規格書 Documents NO. PKG-PH128800T004-ZFC LCM Packaging Specifications Oliver Stone						Kevin			
1.包裝材料規格表 (Packaging Material): (per carton)									
No.	Item	(Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight		
1	成品 (LCM)		PH128800T004-ZFC	254.96 X 173.6	0.458	12	5.496		
2	舒美墊(1)EPE		FOAM000000228	286X 247 X 10	0.0156	12	0.1872		
3	舒美墊(2)EPE		FOAM000000229	286 X 247 X 40	0.031	12	0.372		
4	内盒(3)Product Bo)X	BX00000000111	310 X 255 X 55	0.143	12	1.716		
5	外紙箱(4)Carton	· A	BX52732536CCBA	527 X 325 X 360	1.092	1	1.092		
6	7 1 10 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		B120270200000B11	327 11 323 11 300	1.052		1.052		
7									
8									
9									
	L · 敕筘鹵重昰 (Tota)	LLCD Weight	in carton): 8.86 Kg±1	0%					
2. 3.單	ニーニュー (Total ニ 新動量規格表 (Pac	ckaging Specifi	cations and Quantity):	070		4			
	otal LCM quantity in			x no of boxes	12 =	12			
	1	1	1		12	12			
	(2) 舒美 EP (3)内盒 Product	E							
			特記事」	頁 (REMARK)	OWERTIP				
	TYPE ID.NO S/O O'TY Pcs Date Lot.NO Note								